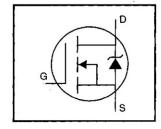
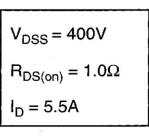
International

IRF730PbF

HEXFET[®] Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

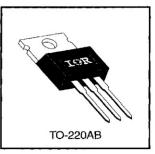




Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



Absolute Maximum Ratings

	Parameter	Max.	Units		
I _D @ T _C = 25°C	Continuous Drain Current, VGS @ 10 V	5.5			
ID @ Tc = 100°C	Continuous Drain Current, VGS @ 10 V	3.5	A		
IDM	Pulsed Drain Current ① 22				
P _D @ T _C = 25°C	Power Dissipation	74	W		
	Linear Derating Factor	0.59	W/°C		
V _{GS}	Gate-to-Source Voltage	±20	V		
Eas	Single Pulse Avalanche Energy ②	290	mJ		
lar	Avalanche Current ①	5.5	A		
EAR	Repetitive Avalanche Energy ①	7.4	mJ		
dv/dt	Peak Diode Recovery dv/dt ③	4.0	V/ns		
TJ T _{STG}	Operating Junction and Storage Temperature Range	-55 to +150	°C		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)			
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)			

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
RejC .	Junction-to-Case			1.7	
Recs	Case-to-Sink, Flat, Greased Surface	—	0.50		°C/W
Reja	Junction-to-Ambient			62]

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International **TCR** Rectifier

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
V(BR)DSS	Drain-to-Source Breakdown Voltage	400	_	_	V	V _{GS} =0V, I _D = 250µA
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	—	0.54		V/°C	Reference to 25°C, ID= 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance	-	- 1	1.0	Ω	V _{GS} =10V, I _D =3.3A ④
V _{GS} (th)	Gate Threshold Voltage	2.0	-	4.0	V	V _{DS} =V _{GS} , I _D = 250μA
g fs	Forward Transconductance	2.9		—	S	V _{DS} =50V, I _D =3.3A ④
1	Drain to Source Leokage Current	-		25		V _{DS} =400V, V _{GS} =0V
loss	Drain-to-Source Leakage Current	I —	—	250	μA	V _{DS} =320V, V _{GS} =0V, T _J =125°C
lass	Gate-to-Source Forward Leakage	_	_	100	nA	V _{GS} =20V
IGSS	Gate-to-Source Reverse Leakage	—		-100	nA	V _{GS} =-20V
Qg	Total Gate Charge	_	—	38		I _D =3.5A
Q _{gs}	Gate-to-Source Charge			5.7	nC	V _{DS} =320V
Q _{gd}	Gate-to-Drain ("Miller") Charge		—	22		V _{GS} =10V See Fig. 6 and 13 ④
td(on)	Turn-On Delay Time		10			V _{DD} =200V
tr	Rise Time		15	—	ns	ID=3.5A
td(off)	Turn-Off Delay Time	-	38	-	113	$R_{G}=12\Omega$
tr	Fall Time		14	—		R _D =57Ω Seé Figure 10 ④
LD	Internal Drain Inductance	-	4.5		nH	Between lead, 6 mm (0.25in.)
Ls	Internal Source Inductance	-	7.5		111-1	from package and center of die contact
Ciss	Input Capacitance	_	700	—		V _{GS} =0V
Coss	Output Capacitance		170		pF	V _{DS} =25V
Crss	Reverse Transfer Capacitance	_	64	_		f=1.0MHz See Figure 5

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

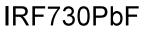
	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)	_		5.5	^	MOSFET symbol showing the
ISM	Pulsed Source Current (Body Diode) ①	-		22	Α	integral reverse p-n junction diode.
VSD	Diode Forward Voltage	. —	-	1.6	V	TJ=25°C, IS=5.5A, VGS=0V @
t _{rr}	Reverse Recovery Time		270	530	ns	TJ=25°C, I⊧=3.5A
Qrr	Reverse Recovery Charge	_	1.8	2.2	μC	di/dt=100A/µs ④
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)				

Notes:

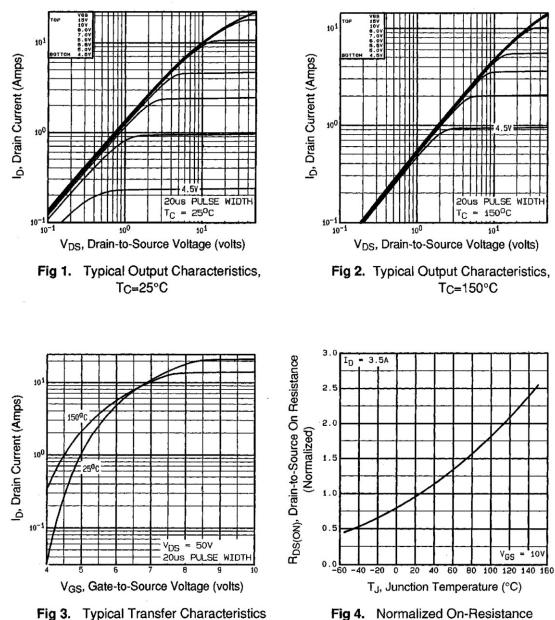
- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- $(3) I_{SD} \leq 5.5A, di/dt \leq 90A/\mu s, V_{DD} \leq V_{(BR)DSS},$ TJ≤150°C
- ② V_{DD}=50V, starting T_J=25°C, L=16mH RG=25Ω, IAS=5.5A (See Figure 12)

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④ Pulse width \leq 300 µs; duty cycle \leq 2%.



International

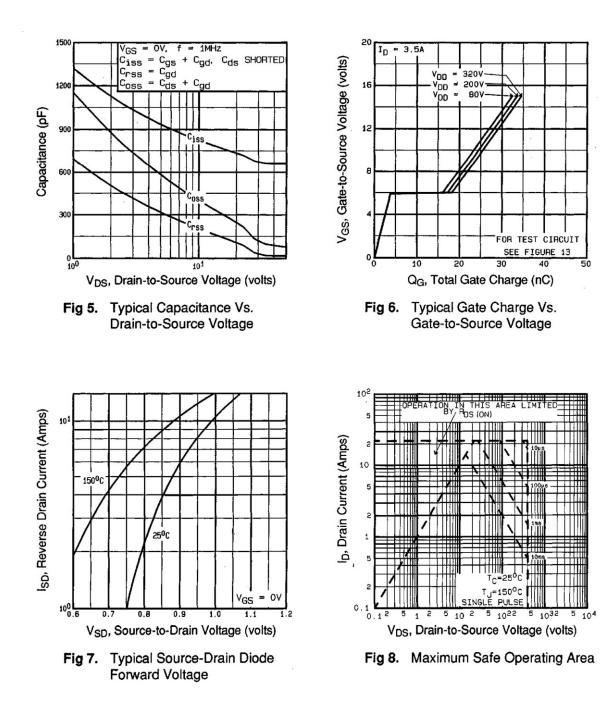


Vs. Temperature

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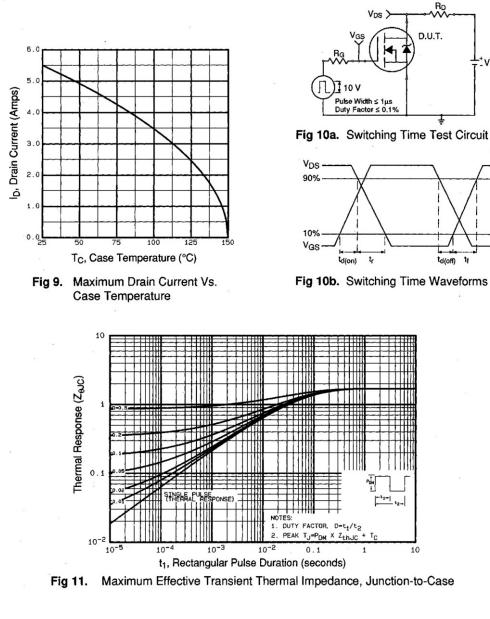


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⁺V_{DD}

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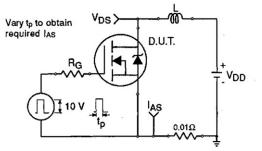


Fig 12a. Unclamped Inductive Test Circuit

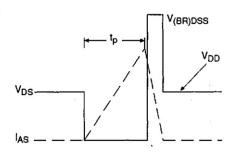


Fig 12b. Unclamped Inductive Waveforms

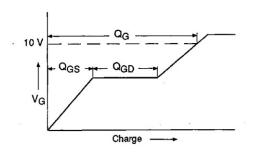


Fig 13a. Basic Gate Charge Waveform

Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit – See page 1505 Appendix B: Package Outline Mechanical Drawing – See page 1509

Appendix E: Optional Leadforms - See page 1525

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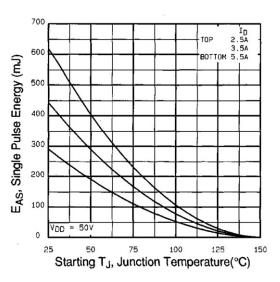


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

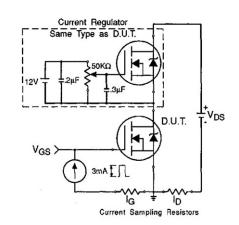


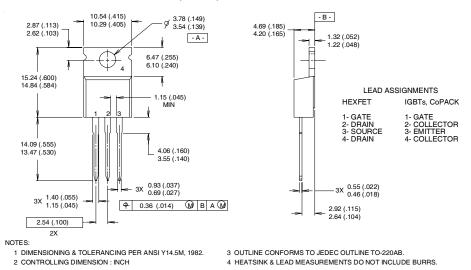
Fig 13b. Gate Charge Test Circuit

International



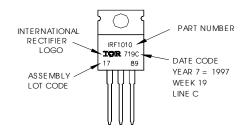
TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789 ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C" Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

International

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903 02/04

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